Bulletin PD-20716 rev. D 01/07

International
IOR Rectifier

MBR30...CT
MBRB30...CT
MBR30...CT-1

SCHOTTKY RECTIFIER

30 Amp

$I_{F(AV)}$ = 30Amp
V_R = 30 - 45V

Major Ratings and Characteristics

Characteristics		Values	Units
$I_{F(AV)}$	Rectangular waveform (Per Device)	30	A
I_{FRM}	@ T_C = 123°C (Per Leg)	30	A
V_{RRM}		35-45	V
I_{FSM}	@ tp = 5 µs sine	1020	A
V_F	@ 20 Apk, T_J = 125°C	0.6	V
T_J	range	-65 to 150	°C

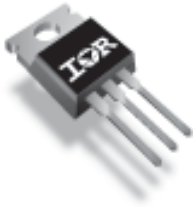
Description/ Features

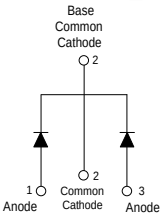
This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150° C junction temperature. Typical applications are in switching power supplies, converters, free-wheeling diodes, and reverse battery protection.

- 150° C T_J operation
- Center tap TO-220, D^2Pak and TO-262 packages
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability

Case Styles

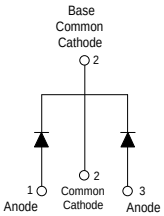
MBR30..CT





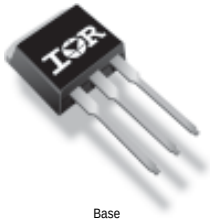
TO-220

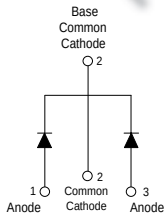
MBR30.. S



D^2PAK

MBR30.. -1





TO-262

Voltage Ratings

	Parameters	MBR3035CT MBRB3035CT MBR3035CT-1	MBR3045CT MBRB3045CT MBR3045CT-1
V_R	Max. DC Reverse Voltage (V)	35	45
V_{RWM}	Max. Working Peak Reverse Voltage (V)		

Absolute Maximum Ratings

	Parameters	Values	Units	Conditions	
$I_{F(AV)}$	Max. Average Forward (Per Leg) Current (Per Device)	15 30	A	@ T_C = 123° C, (Rated V_R)	
I_{FRM}	Peak Repetitive Forward Current (Per Leg)	30	A	Rated V_R, square wave, 20kHz T_C = 123° C	
I_{FSM}	Non Repetitive Peak Surge Current	1020	A	5µs Sine or 3µs Rect. pulse	Following any rated load condition and with rated V_{RRM} applied
		200		Surge applied at rated load conditions halfwave, single phase, 60Hz	
E_{AS}	Non-Repetitive Avalanche Energy	10	mJ	(Per Leg) T_J = 25 °C, I_{AS} = 2 Amps, L = 5 mH	
I_{AR}	Repetitive Avalanche Current (Per Leg)	2	A	Current decaying linearly to zero in 1 µsec Frequency limited by T_J max. V_A = 1.5 x V_R typical	

Electrical Specifications

	Parameters	Values	Units	Conditions	
V_{FM}	Max. Forward Voltage Drop (1)	0.76	V	@ 30A	T_J = 25 °C
		0.6	V	@ 20A	T_J = 125 °C
		0.72	V	@ 30A	
I_{RM}	Max. Instantaneus Reverse Current (1)	1	mA	T_J = 25 °C	Rated DC voltage
		100	mA	T_J = 125 °C	
$V_{F(TO)}$	Threshold Voltage	0.29	V	T_J = T_J max.	
r_t	Forward Slope Resistance	13.6	mΩ		
C_T	Max. Junction Capacitance	800	pF	V_R = 5V_{DC} (test signal range 100Khz to 1Mhz) 25°C	
L_S	Typical Series Inductance	8.0	nH	Measured from top of terminal to mounting plane	
dv/dt	Max. Voltage Rate of Change	10000	V/ µs	(Rated V_R)	

(1) Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications

	Parameters		Values	Units	Conditions
T_J	Max. Junction Temperature Range		-65 to 150	°C	
T_{stg}	Max. Storage Temperature Range		-65 to 175	°C	
R_{thJC}	Max. Thermal Resistance Junction to Case (Per Leg)		1.5	°C/W	DC operation
R_{thCS}	Typical Thermal Resistance Case to Heatsink		0.50	°C/W	Mounting surface, smooth and greased Only for TO-220
R_{thJA}	Max. Thermal Resistance Junction to Ambient		50	°C/W	DC operation For D^2Pak and TO-262
wt	Approximate Weight		2 (0.07)	g (oz.)	
T	Mounting Torque	Min.	6 (5)	Kg-cm (lbf-in)	Non-lubricated threads
		Max.	12 (10)		

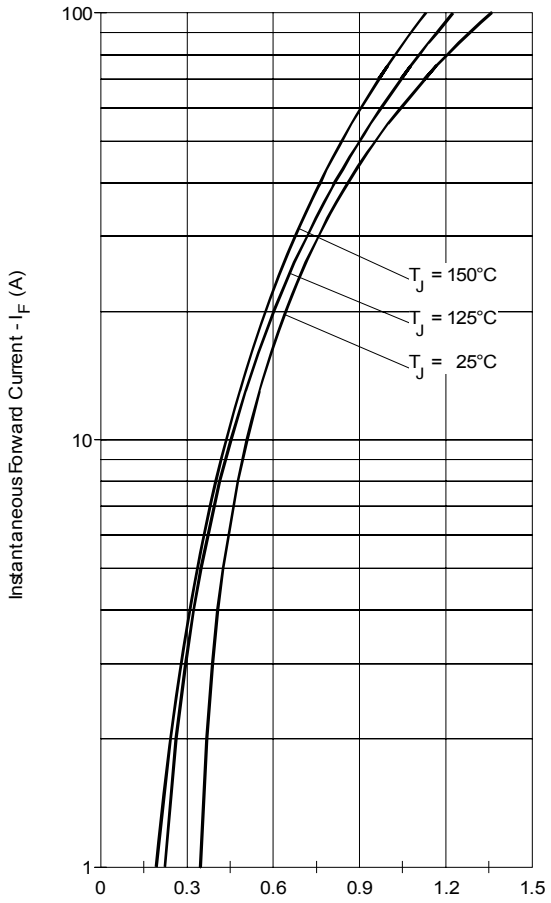


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

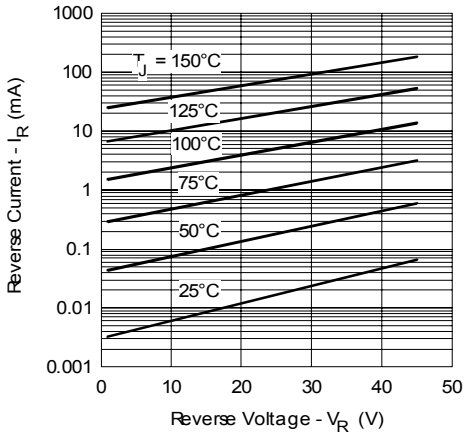


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage (Per Leg)

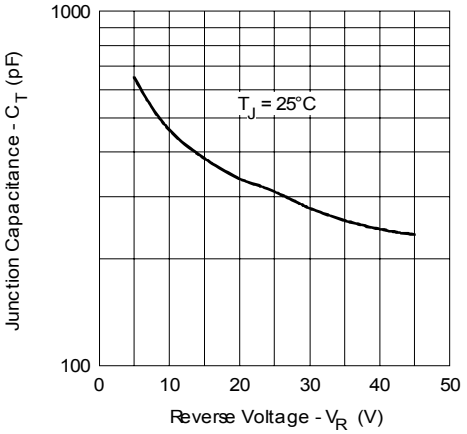


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

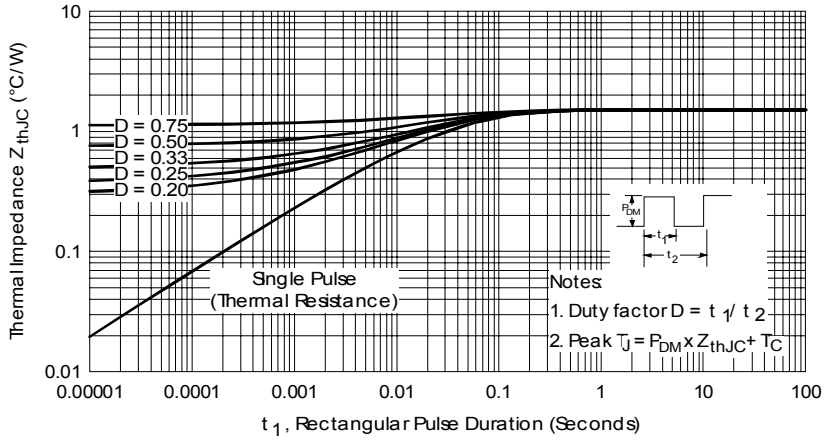


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

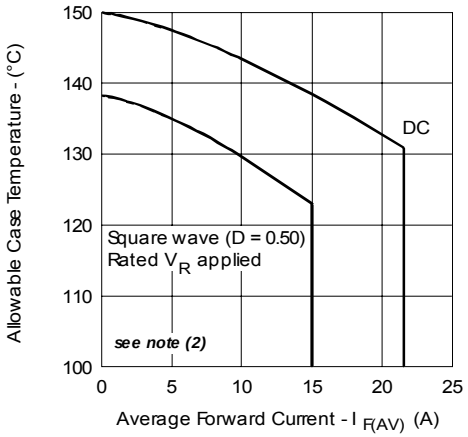


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current (Per Leg)

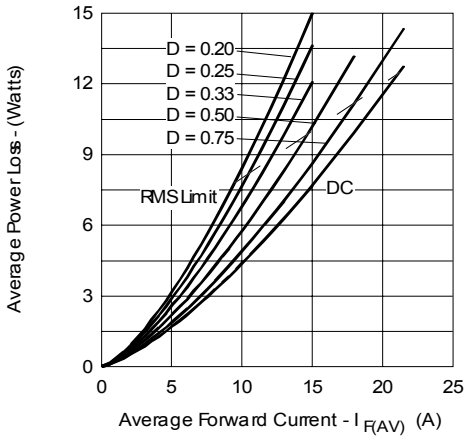


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

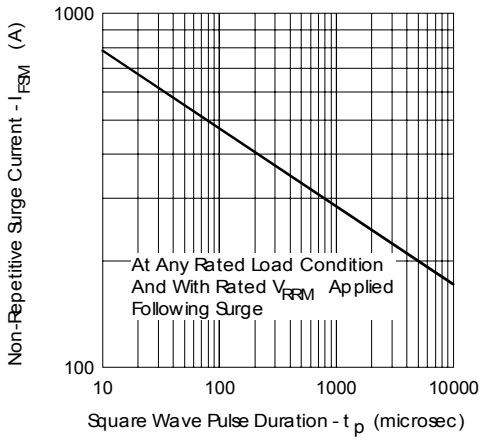
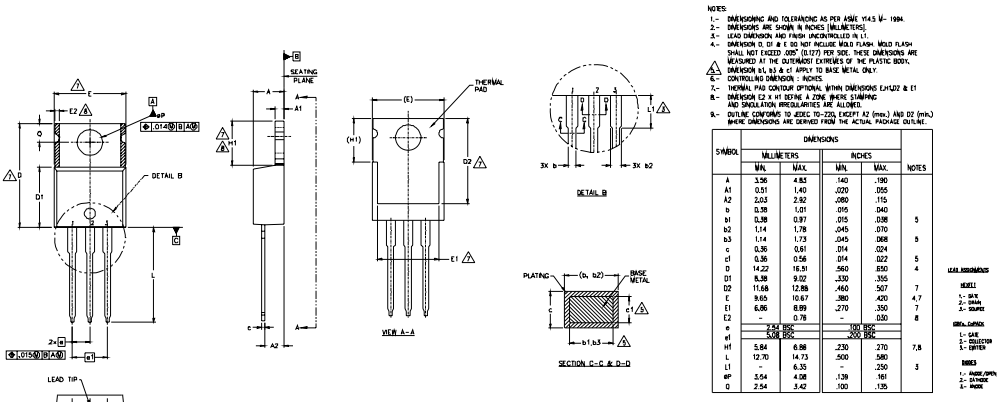


Fig. 7 - Max. Non-Repetitive Surge Current (Per Leg)

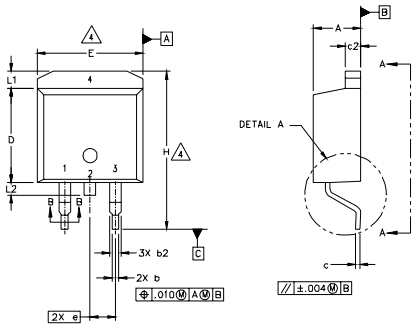
(2) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
Pd = Forward Power Loss = $I_{F(AV)} \times V_{FM} @ (I_{F(AV)} / D)$ (see Fig. 6);
Pd_{REV} = Inverse Power Loss = $V_{R1} \times I_R (1 - D)$; $I_R @ V_{R1}$ = rated V_R

Outline Table



SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	3.56	4.83	.140	.190	
A1	0.51	1.40	.020	.055	
A2	2.03	2.92	.080	.115	
b	0.38	1.01	.015	.040	
b1	0.38	0.97	.015	.038	5
b2	1.14	1.78	.045	.070	
b3	1.14	1.73	.045	.068	5
c	0.36	0.61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14.22	16.51	.560	.650	4
D1	8.38	9.02	.330	.355	
D2	11.68	12.88	.460	.507	7
E	9.65	10.67	.380	.420	4,7
E1	6.86	8.89	.270	.350	7
E2	-	0.76	-	0.03	8
e	2.54 BSC		100 BSC		
e1	5.08 BSC		.200 BSC		
H1	5.84	6.86	.230	.270	7,8
L	12.70	14.73	.500	.580	
L1	-	6.35	-	.250	3
øP	3.54	4.08	.139	.161	
Q	2.54	3.42	.100	.135	

Conform to JEDEC outline TO-220AB



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
4. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
5. CONTROLLING DIMENSION: INCH.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	
A1	0.00	0.254	.000	.010	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	4
b2	1.14	1.78	.045	.070	
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	4
c2	1.14	1.65	.045	.065	
D	8.51	9.65	.335	.380	3
D1	6.86		.270		
E	9.65	10.67	.380	.420	3
E1	6.22		.245		
e	2.54 BSC		.100 BSC		
H	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1		1.65		.065	
L2	1.27	1.78	.050	.070	
L3	0.25 BSC		.010 BSC		
L4	4.78	5.28	.188	.208	
m	17.78		.700		
m1	8.89		.350		
n	11.43		.450		
o	2.08		.082		
p	3.81		.150		
R	0.51	0.71	.020	.028	
θ	90°	93°	90°	93°	

LEAD ASSIGNMENTS

HEXFET

1.– GATE
2, 4.– DRAIN
3.– SOURCE

IGBTs, CoPACK

1.– GATE
2, 4.– COLLECTOR
3.– EMITTER

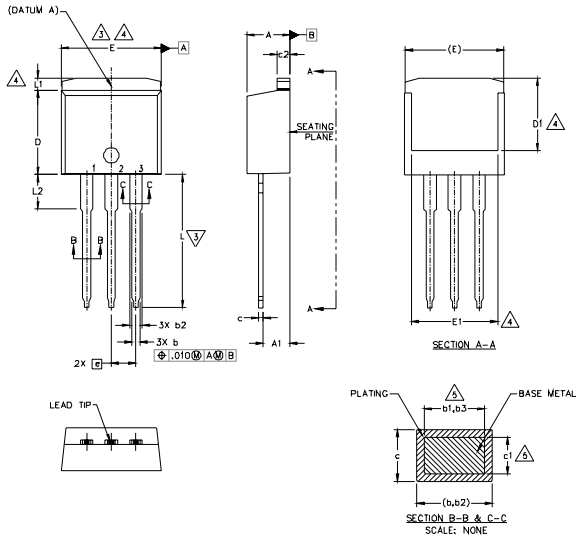
DIODES

1.– ANODE *
2, 4.– CATHODE
3.– ANODE

* PART DEPENDENT.

Conform to JEDEC outline D^2Pak (SMD-220)
Dimensions in millimeters and (inches)

Outline Table



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
5. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
6. CONTROLLING DIMENSION: INCH.
7.– OUTLINE CONFORM TO JEDEC TO–262 EXCEPT A1(max.), b(min.) AND D1(min.) WHERE DIMENSIONS DERIVED THE ACTUAL PACKAGE OUTLINE.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	
A1	2.03	3.02	.080	.119	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	5
b2	1.14	1.78	.045	.070	
b3	1.14	1.73	.045	.068	5
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	5
c2	1.14	1.65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86	–	.270	–	4
E	9.65	10.67	.380	.420	3,4
E1	6.22	–	.245		4
e	2.54 BSC		.100 BSC		
L	13.46	14.10	.530	.555	
L1	–	1.65	–	.065	4
L2	3.56	3.71	.140	.146	

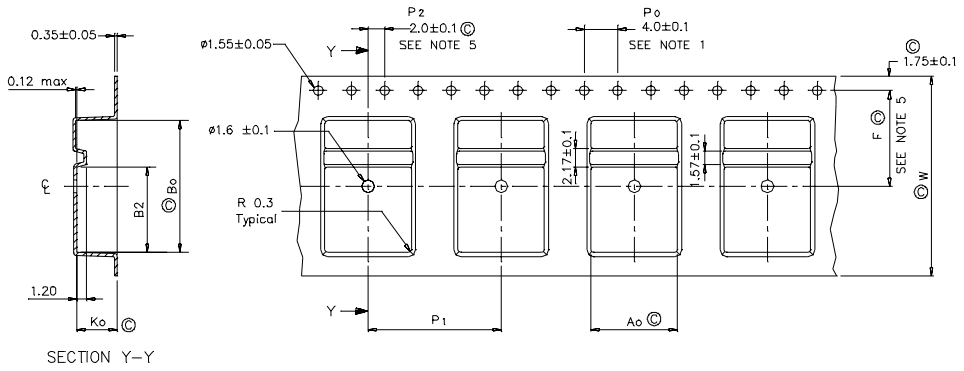
LEAD ASSIGNMENTS

HEXFET
1.– GATE
2.– DRAIN
3.– SOURCE
4.– DRAIN

IGBTs, CoPACK
1.– GATE
2.– COLLECTOR
3.– EMITTER
4.– COLLECTOR

Modified JEDEC outline TO-262
Dimensions in millimeters and (inches)

Tape & Reel Information



Ao	10.50 +/– 0.1
Bo	15.80 +/– 0.1
B2	10.25 +/– 0.1
Ko	4.90 +/– 0.1
F	11.50 +/– 0.1
P1	16.00 +/– 0.1
W	24.00 +/– 0.3

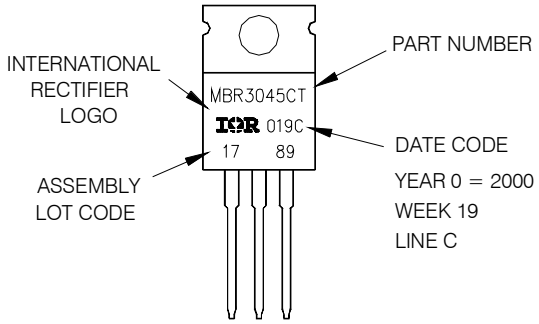
NOTES:
1.0 10 SPROCKET HOLE PITH CUMULATIVE TOLERANCE ±.02
2.0 CAMBER NOT TO EXCEED 1mm in 100mm
3.0 MATERIAL: CONDUCTIVE BLACK STYRENIC ALLOY
4.0 Ko MEASURED FROM A PLANE ON THE INSIDE BOTTOM OF THE POCKET TO THE TOP SURFACE OF THE CARRIER
5.0 MEASURED FROM CENTRELINE OF SPROCKET HOLE TO CENTRELINE OF POCKET
6.0 VENDOR: (OPTIONAL)
7.0 MUST ALSO MEET REQUIREMENTS OF EIA STANDAR #EIA–481A TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC PLACEMENT
8.0 SURFACE RESISTIVITY OF MOLDED MATL. MUST MEASURE LESS OR EQUAL TO 10^6 OHMS PER SQUARE. MEASURED IN ACCORDANCE TO PROCEDURE GIVEN IN ASTM D–257 & ASTM D–991
9.0 TOTAL LENGTH PER REEL MUST BE 45 METERS
10.0 Ⓒ CRITICAL

Dimensions in millimeters and (inches)

Part Marking Information

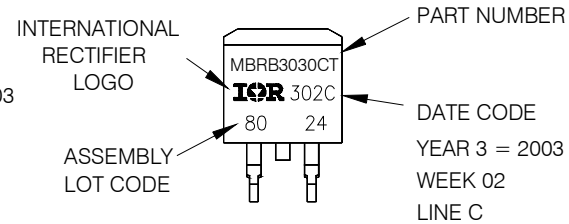
TO-220

EXAMPLE: THIS IS A MBR3045CT
LOT CODE 1789
ASSEMBLED ON WW 19, 2000
IN THE ASSEMBLY LINE "C"



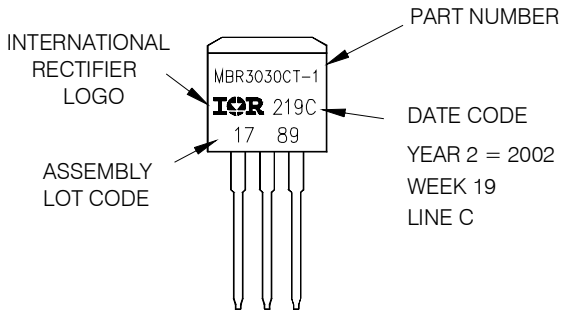
D^2PAK

EXAMPLE: THIS IS A MBRB3030CT
LOT CODE 8024
ASSEMBLED ON WW 02, 2003
IN ASSEMBLY LINE "C"



TO-262

EXAMPLE: THIS IS A MBR3030CT-1
LOT CODE 1789
ASSEMBLED ON WW 19, 2002
IN ASSEMBLY LINE "C"



Ordering Information Table

Device Code

MBR	B	30	45	CT	-1	TRL	-
1	2	3	4	5	6	7	8

1 - Essential Part Number

2 - • B = D^2Pak **6** none
• none = TO-220 **6** none
• none= TO-262 **6** = -1

3 - Current Rating (30 = 30A)

4 - Voltage Ratings — 35 = 35V, 45 = 45V

5 - CT = Essential Part Number

6 - • none = TO-220 **2** none
• none = D^2Pak **2** = B
• -1 = TO-262 **2** none

7 - • none = Tube (50 pieces)
• TRL = Tape & Reel (Left Oriented - for D^2Pak only)
• TRR = Tape & Reel (Right Oriented - for D^2Pak only)

8 - • none = Standard Production
• PbF = Lead-Free (for TO-220TO-262 and D^2Pak tube)
• P = Lead-Free (for D^2Pak TRR and TRL)

Data and specifications subject to change without notice.
This product has been designed and qualified for Industrial Level.
Qualification Standards can be found on IR's Web site.

International IOR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7309
Visit us at www.irf.com for sales contact information. 01/07